



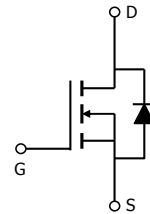
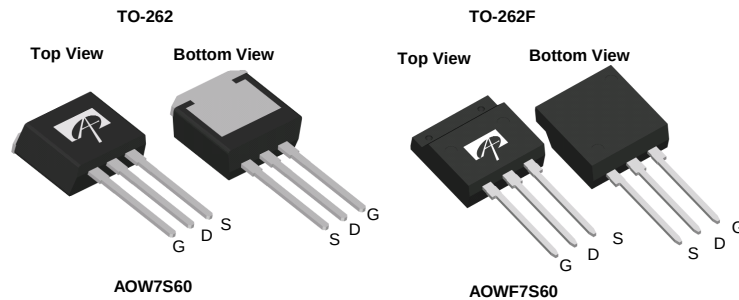
General Description

The AOW7S60 & AOWF7S60 have been fabricated using the advanced α MOS™ high voltage process that is designed to deliver high levels of performance and robustness in switching applications. By providing low $R_{DS(on)}$, Q_g and E_{OSS} along with guaranteed avalanche capability these parts can be adopted quickly into new and existing offline power supply designs.

Product Summary

$V_{DS} @ T_{j,max}$	700V
I_{DM}	33A
$R_{DS(on),max}$	0.6 Ω
$Q_{g,typ}$	8.2nC
$E_{OSS} @ 400V$	1.9 μ J

100% UIS Tested
100% R_g Tested



Absolute Maximum Ratings $T_A=25^\circ\text{C}$ unless otherwise noted

Parameter	Symbol	AOW7S60	AOWF7S60	Units
Drain-Source Voltage	V_{DS}	600		V
Gate-Source Voltage	V_{GS}	± 30		V
Continuous Drain Current	I_D	7	7*	A
		5	5*	
Pulsed Drain Current ^C	I_{DM}	33		
Avalanche Current ^C	I_{AR}	1.7		A
Repetitive avalanche energy ^C	E_{AR}	43		mJ
Single pulsed avalanche energy ^G	E_{AS}	86		mJ
Power Dissipation ^B	P_D	104	25	W
		0.8	0.2	W/°C
MOSFET dv/dt ruggedness	dv/dt	100		V/ns
Peak diode recovery dv/dt ^H		20		
Junction and Storage Temperature Range	T_J, T_{STG}	-55 to 150		°C
Maximum lead temperature for soldering purpose, 1/8" from case for 5 seconds ^J	T_L	300		°C

Thermal Characteristics

Parameter	Symbol	AOW7S60	AOWF7S60	Units
Maximum Junction-to-Ambient ^{A,D}	$R_{\theta JA}$	65	65	°C/W
Maximum Case-to-sink ^A	$R_{\theta CS}$	0.5	--	°C/W
Maximum Junction-to-Case	$R_{\theta JC}$	1.2	5	°C/W

* Drain current limited by maximum junction temperature.

Electrical Characteristics (T_J=25°C unless otherwise noted)

Symbol	Parameter	Conditions	Min	Typ	Max	Units
STATIC PARAMETERS						
BV _{DSS}	Drain-Source Breakdown Voltage	I _D =250μA, V _{GS} =0V, T _J =25°C	600	-	-	V
		I _D =250μA, V _{GS} =0V, T _J =150°C	650	700	-	
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} =600V, V _{GS} =0V	-	-	1	μA
		V _{DS} =480V, T _J =150°C	-	10	-	
I _{GSS}	Gate-Body leakage current	V _{DS} =0V, V _{GS} =±30V	-	-	±100	nA
V _{GS(th)}	Gate Threshold Voltage	V _{DS} =5V, I _D =250μA	2.7	3.3	3.9	V
R _{DS(ON)}	Static Drain-Source On-Resistance	V _{GS} =10V, I _D =3.5A, T _J =25°C	-	0.54	0.60	Ω
		V _{GS} =10V, I _D =3.5A, T _J =150°C	-	1.48	1.64	Ω
V _{SD}	Diode Forward Voltage	I _S =3.5A, V _{GS} =0V, T _J =25°C	-	0.82	-	V
I _S	Maximum Body-Diode Continuous Current		-	-	7	A
I _{SM}	Maximum Body-Diode Pulsed Current ^C		-	-	33	A
DYNAMIC PARAMETERS						
C _{iss}	Input Capacitance	V _{GS} =0V, V _{DS} =100V, f=1MHz	-	372	-	pF
C _{oss}	Output Capacitance		-	28	-	pF
C _{o(er)}	Effective output capacitance, energy related ^H	V _{GS} =0V, V _{DS} =0 to 480V, f=1MHz	-	22	-	pF
C _{o(tr)}	Effective output capacitance, time related ^I		-	65	-	pF
C _{rss}	Reverse Transfer Capacitance	V _{GS} =0V, V _{DS} =100V, f=1MHz	-	1.2	-	pF
R _g	Gate resistance	V _{GS} =0V, V _{DS} =0V, f=1MHz	-	17.5	-	Ω
SWITCHING PARAMETERS						
Q _g	Total Gate Charge	V _{GS} =10V, V _{DS} =480V, I _D =3.5A	-	8.2	-	nC
Q _{gs}	Gate Source Charge		-	2.0	-	nC
Q _{gd}	Gate Drain Charge		-	2.8	-	nC
t _{D(on)}	Turn-On DelayTime	V _{GS} =10V, V _{DS} =400V, I _D =3.5A, R _G =25Ω	-	19	-	ns
t _r	Turn-On Rise Time		-	13	-	ns
t _{D(off)}	Turn-Off DelayTime		-	50	-	ns
t _f	Turn-Off Fall Time		-	15	-	ns
t _{rr}	Body Diode Reverse Recovery Time	I _F =3.5A, dI/dt=100A/μs, V _{DS} =400V	-	198	-	ns
I _{rm}	Peak Reverse Recovery Current	I _F =3.5A, dI/dt=100A/μs, V _{DS} =400V	-	18	-	A
Q _{rr}	Body Diode Reverse Recovery Charge	I _F =3.5A, dI/dt=100A/μs, V _{DS} =400V	-	2.4	-	μC

A. The value of R_{θJA} is measured with the device in a still air environment with T_A=25°C.

B. The power dissipation P_D is based on T_{J(MAX)}=150°C, using junction-to-case thermal resistance, and is more useful in setting the upper dissipation limit for cases where additional heatsinking is used.

C. Repetitive rating, pulse width limited by junction temperature T_{J(MAX)}=150°C. Ratings are based on low frequency and duty cycles to keep initial T_J=25°C.

D. The R_{θJA} is the sum of the thermal impedance from junction to case R_{θJC} and case to ambient.

E. The static characteristics in Figures 1 to 6 are obtained using <300 μs pulses, duty cycle 0.5% max.

F. These curves are based on the junction-to-case thermal impedance which is measured with the device mounted to a large heatsink, assuming a maximum junction temperature of T_{J(MAX)}=150°C. The SOA curve provides a single pulse rating.

G. L=60mH, I_{AS}=1.7A, V_{DD}=150V, Starting T_J=25°C

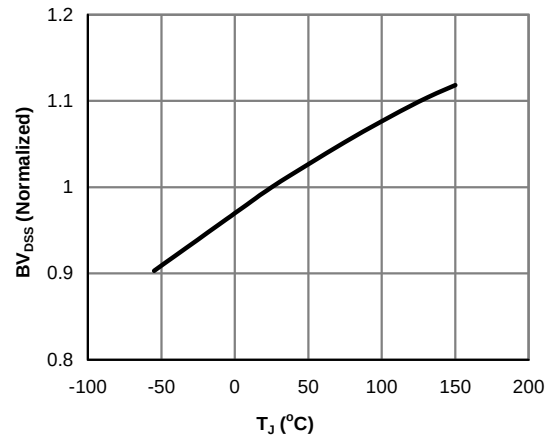
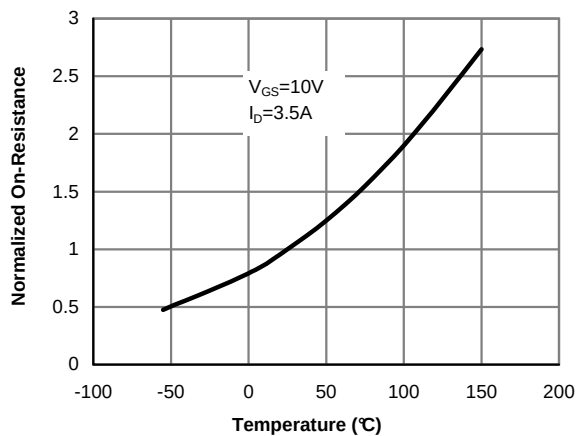
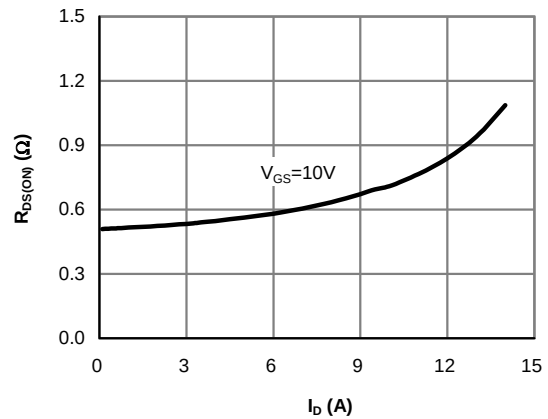
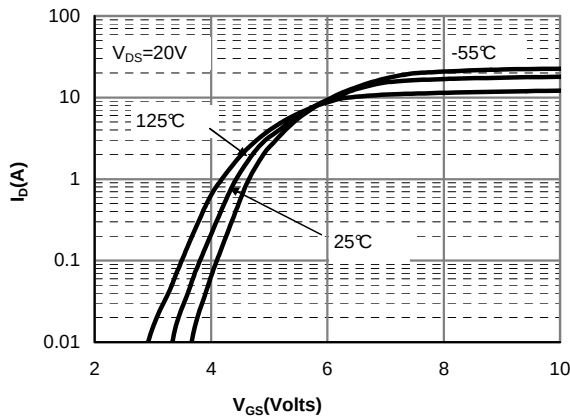
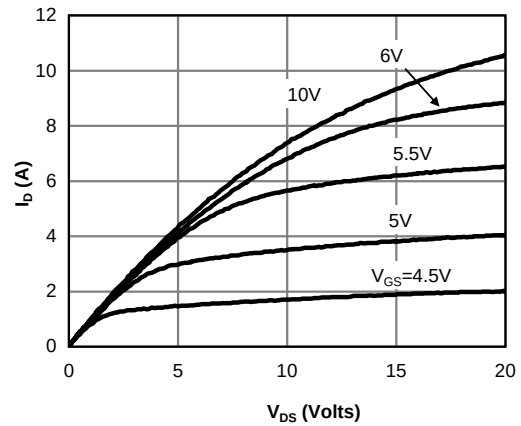
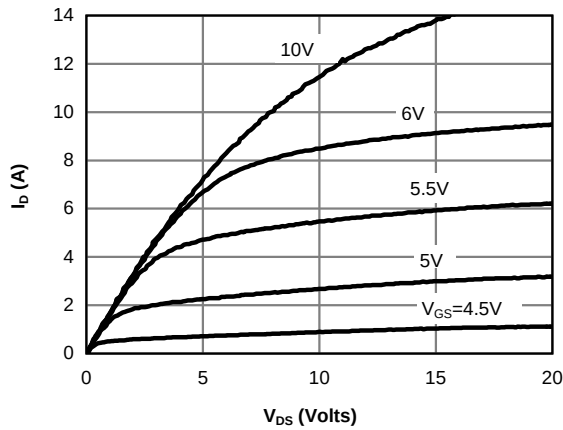
H. C_{o(er)} is a fixed capacitance that gives the same stored energy as C_{oss} while V_{DS} is rising from 0 to 80% V_{(BR)DSS}.

I. C_{o(tr)} is a fixed capacitance that gives the same charging time as C_{oss} while V_{DS} is rising from 0 to 80% V_{(BR)DSS}.

J. Wavesoldering only allowed at leads.

THIS PRODUCT HAS BEEN DESIGNED AND QUALIFIED FOR THE CONSUMER MARKET. APPLICATIONS OR USES AS CRITICAL COMPONENTS IN LIFE SUPPORT DEVICES OR SYSTEMS ARE NOT AUTHORIZED. AOS DOES NOT ASSUME ANY LIABILITY ARISING OUT OF SUCH APPLICATIONS OR USES OF ITS PRODUCTS. AOS RESERVES THE RIGHT TO IMPROVE PRODUCT DESIGN, FUNCTIONS AND RELIABILITY WITHOUT NOTICE.

TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS



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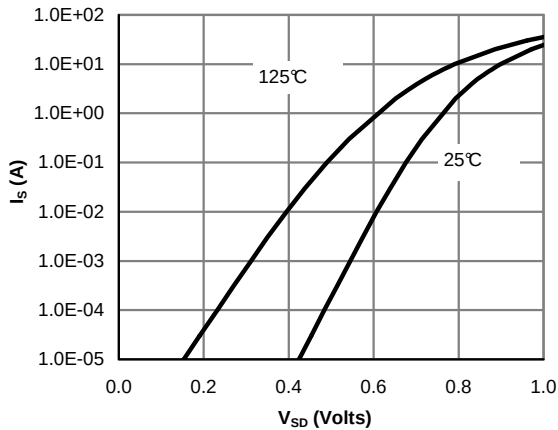


Figure 7: Body-Diode Characteristics (Note E)

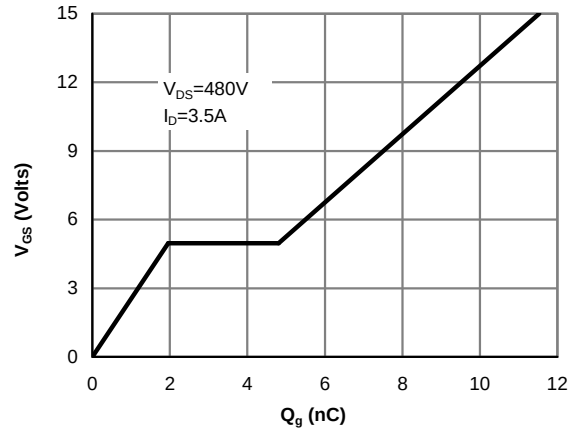


Figure 8: Gate-Charge Characteristics

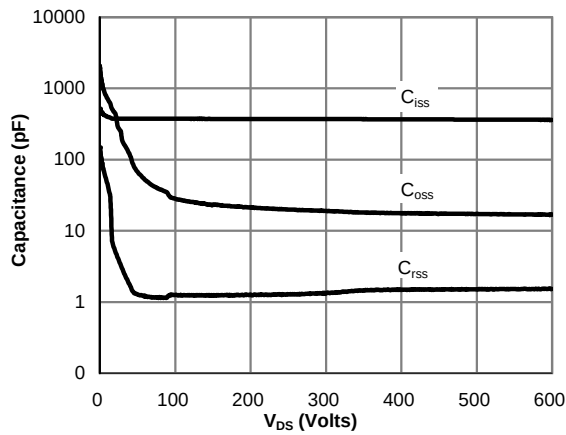


Figure 9: Capacitance Characteristics

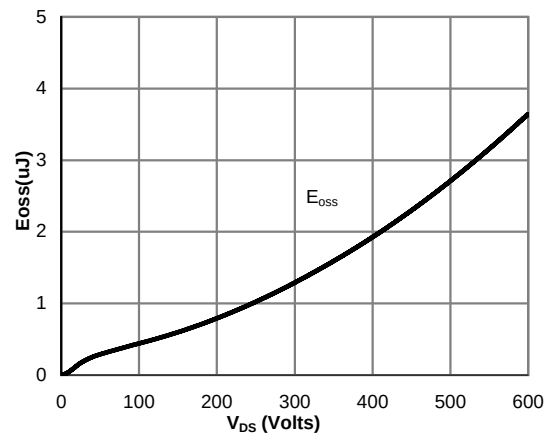


Figure 10: Coss stored Energy

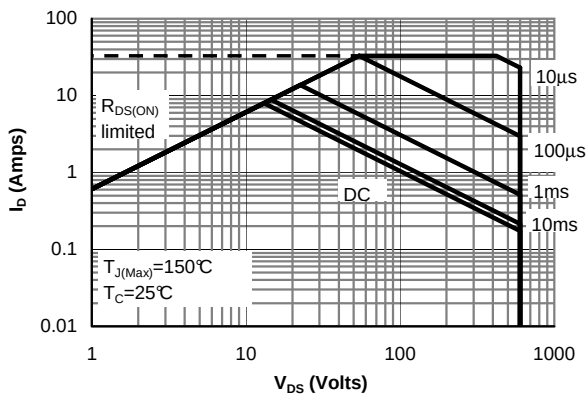


Figure 11: Maximum Forward Biased Safe Operating Area for AOW7S60 (Note F)

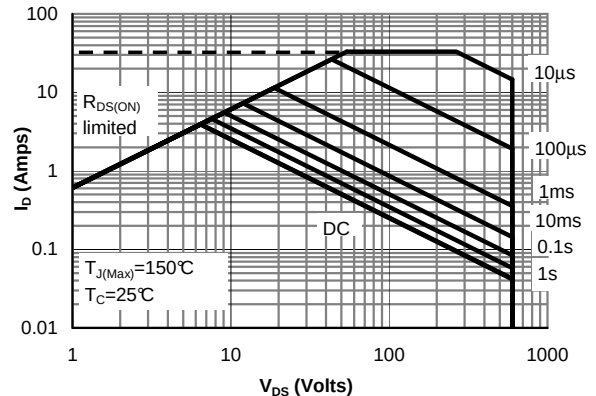


Figure 12: Maximum Forward Biased Safe Operating Area for AOWF7S60 (Note F)

TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS

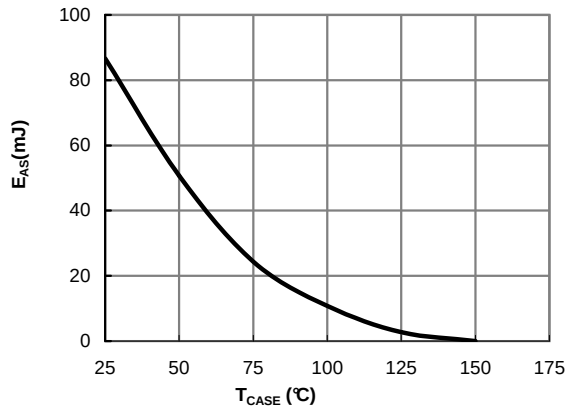


Figure 13: Avalanche energy

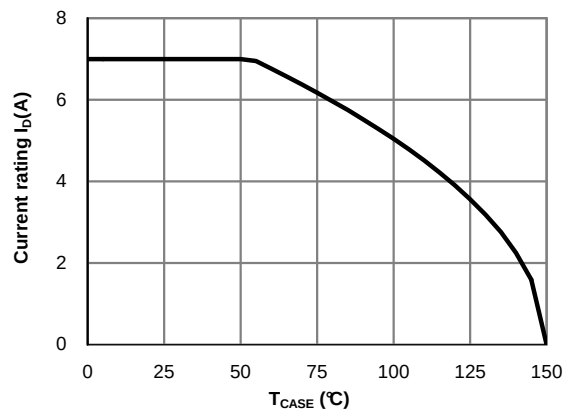


Figure 14: Current De-rating (Note B)

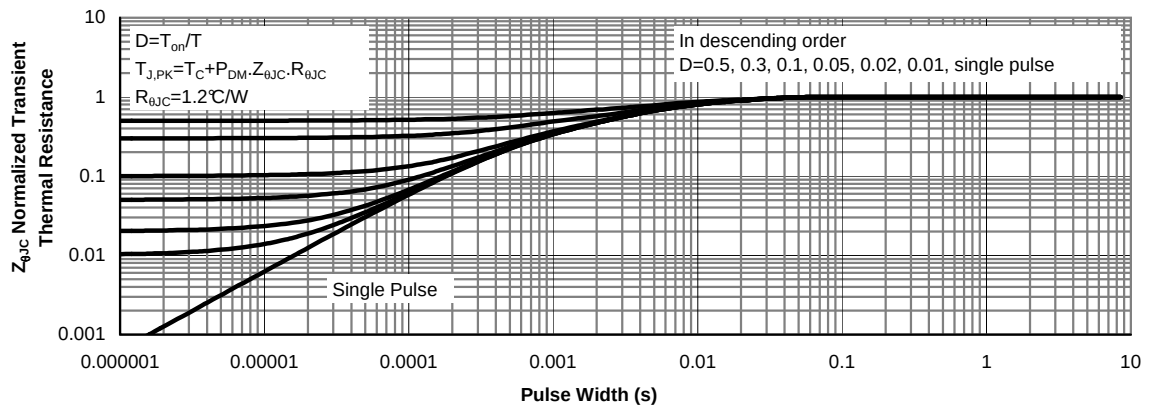


Figure 15: Normalized Maximum Transient Thermal Impedance for AOW7S60 (Note F)

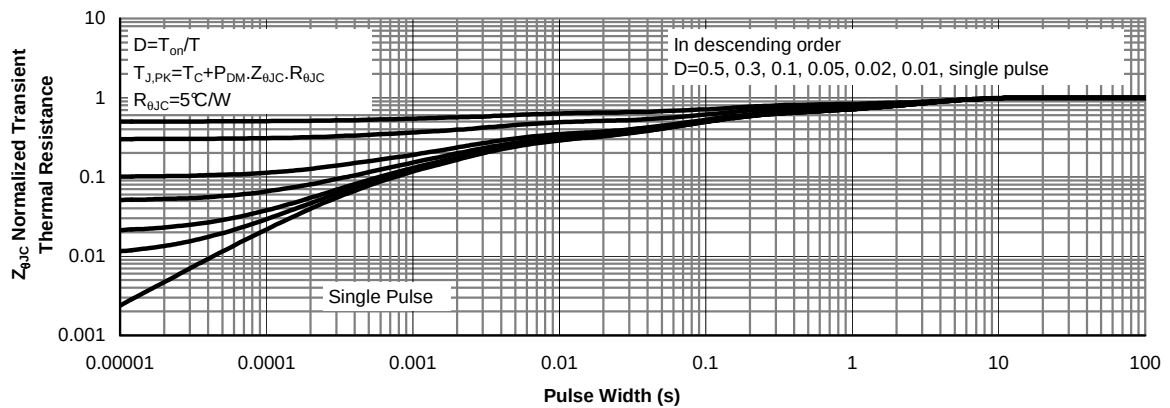
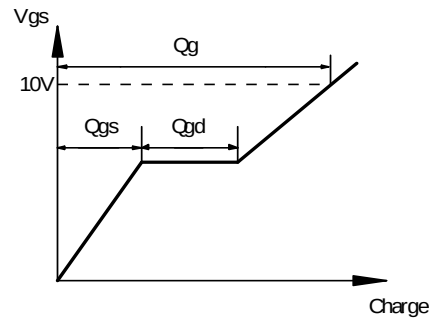
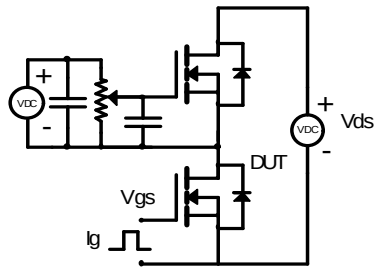
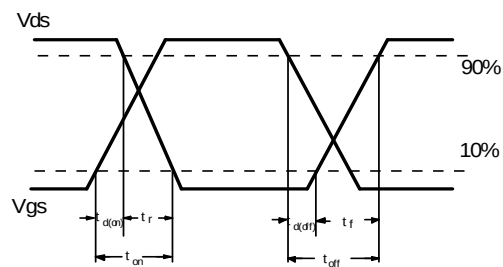
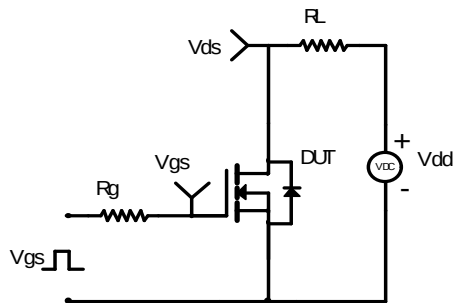


Figure 16: Normalized Maximum Transient Thermal Impedance for AOWF7S60 (Note F)

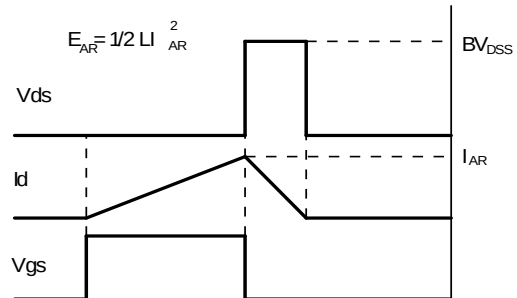
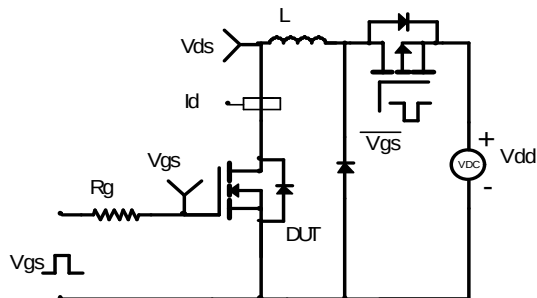
Gate Charge Test Circuit & Waveform



Resistive Switching Test Circuit & Waveforms



Unclamped Inductive Switching (UIS) Test Circuit & Waveforms



Diode Recovery Test Circuit & Waveforms

